

NEW WAYS TO SHRINK: ADVANCED PATTERNING PRODUCTS LAUNCH

February 28, 2023 at 9:00 AM PT
12:00 PT ET



KEITH WELLS

Group Vice President

General Manager

Imaging and Process Control Group (IPC)

Keith Wells joined Applied Materials as General Manager of the Imaging and Process Control Group (IPC). He manages an executive team that oversees both the Process Diagnostics and Control Group (PDC) and the Process Optimization and Control Group (POC).

Prior to joining Applied, Mr. Wells spent two years at Lam Research and 27 years at KLA. At Lam, he held the title of Chief Engineer and CVP and he focused on developing analytical techniques and optical sensors for process control.

At KLA, Mr. Wells spent 27 years in the development of advanced optical and E-Beam wafer inspection tools. In his technical roles, he oversaw the development of light and electron optics, imaging sensors, high speed data acquisition, image computer development, and algorithm development including AI techniques for wafer inspection applications. In his business roles, he served as General Manager of the Electron Beam Division from 2006 to 2010 and then as the General Manager of the Optical Inspection Division from 2010 to 2015.

Mr. Wells holds a Bachelor of Science degree in Physics from Whitman College and holds a Master of Science in Solid State Physics from Washington State University.

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STEVEN SHERMAN

*Managing Director and General Manager
Semiconductor Products Group*

Steven Sherman is Managing Director and General Manager of Advanced Products within the Semiconductor Products Group. During his 10 years at Applied he has worked on identifying, developing and commercializing ion-beam technologies for patterning and other non-doping applications in R&D, Strategic Marketing and Product Management.

Before Applied, Steven held various engineering and operations positions in the telecom and solar industries after starting his career as a process engineer in Intel's Portland Technology Development group. He has over two dozen patents, a PhD in electrical engineering from Princeton University and a BS in applied physics from Columbia University.

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MICHAEL SULLIVAN

*Corporate Vice President
Investor Relations*

Michael Sullivan is Corporate Vice President and head of Investor Relations. His team is responsible for investor relations and marketing communications including media relations, product and technology communications, and industry events.

Mr. Sullivan joined Applied in 2009 after working at Intel Corporation for 16 years. He was Intel's primary interface to equity analysts and the company's largest institutional shareholders in the U.S. and Europe. He also held corporate communications positions at the company's U.S. and European offices, where he drove corporate and competitive initiatives, new microprocessor introductions, computing platform campaigns, and flash memory PR.

Mr. Sullivan is past president of the Silicon Valley chapter of NIRI, the National Investor Relations Institute. He earned his MBA at Santa Clara University and his BA in Public Relations at San Jose State University.